P30LA10SL

Power MOSFETs 100V, 30A, N-channel

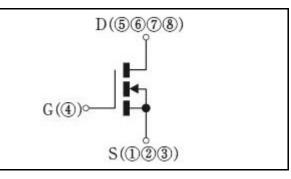
Feature

- N-channel
- Small SMD
- Low Ron
- 4.5V Gate Drive
- Low Capacitance
- Halogen free
- Pb free terminal
- RoHS:Yes

OUTLINE



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : Tc=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	Tstg		-55 to 150	°C
Channel tempertature	Tch		-55 to 150	°C
Drain-source voltage	V _{DSS}		100	V
Gate-source voltage	V _{GSS}		±20	V
Continuous drain current(DC)	Ι _D		30	A
Continuous drain current(Peak)	I _{DP}	Pulse width 10µs, duty=1/100	90	А
Total power dissipation	P _T		142	W
Single avalanche current	I _{AS}	Starting Tch=25°C Tch≦150°C	25	А
Single avalanche energy	E _{AS}	Starting Tch=25°C Tch≦150°C	72	mJ

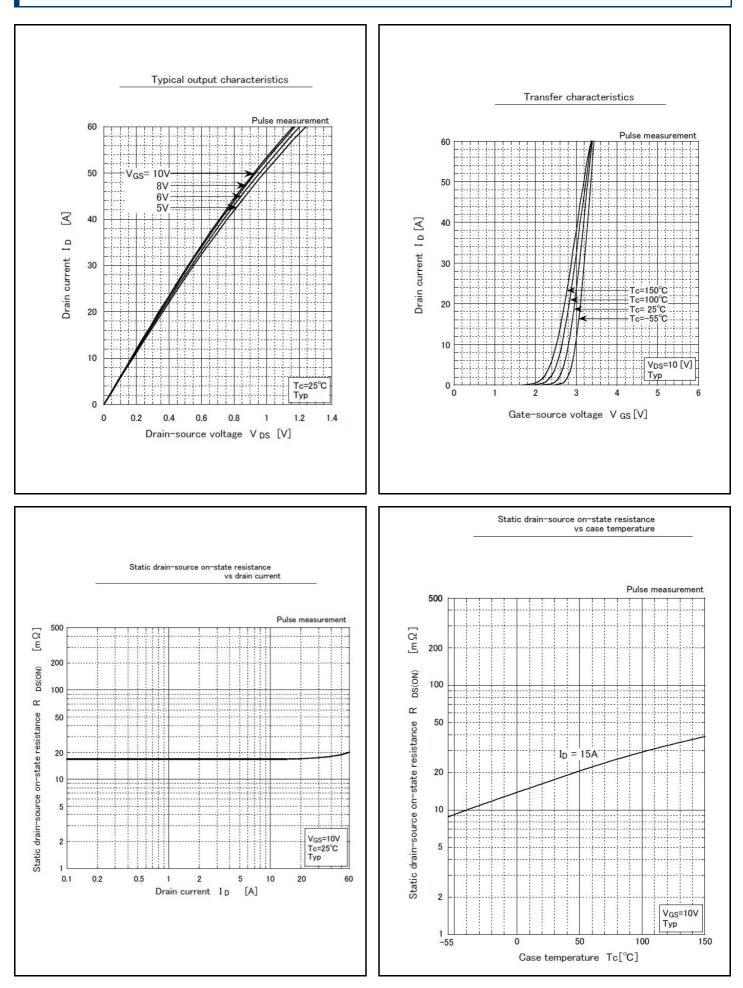
* : See the original Specifications

Electrical Characteristics	(unless otherwise specified : Tc=25°C)

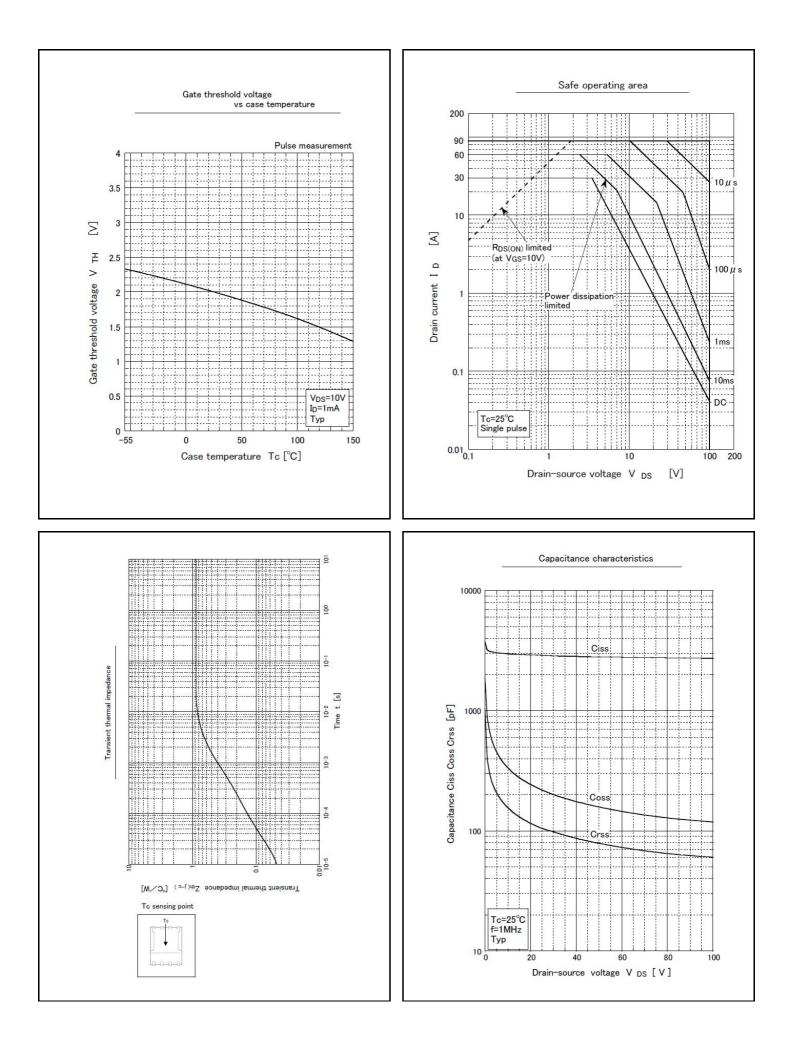
ltem	Symbol	Conditions	Ratings			11
			MIN	ТҮР	MAX	Unit
Drain-Source breakdown voltage	V _{(BR)DSS}	ID=1mA, VGS=0V	100			V
Zero gate voltage drain current	I _{DSS}	VDS=100V, VGS=0V			1	μA
Gate-source leakage current	I _{GSS}	VGS=±20V, VDS=0V			±0.1	μA
Forward transconductance	g fs	ID=15A, VDS=10V	11			S
Static drain-source on-state resistance	R _{DS(ON)}	ID=15A, VGS=10V		0.0168	0.021	Ω
Static drain-source on-state resistance	R _{DS(ON)}	ID=15A, VGS=4.5V		0.0183	0.0244	Ω
Gate threshold voltage	Vth	ID=1mA, VDS=10V	1.5	2	2.5	V
Source-drain diode forward voltage	V _{SD}	IS=30A, VGS=0V			1.5	V
Thermal resistance	Rth(j-c)	Junction to case, with heatsink			0.88	°C/W
Total gate charge	Qg	VDD=80V, VGS=10V, ID=30A		61		nC
Gate to source charge	Qgs	VDD=80V, VGS=10V, ID=30A		11		nC
Gate to drain charge	Qgd	VDD=80V, VGS=10V, ID=30A		16		nC
Input capacitance	Ciss	VDS=25V, VGS=0V, f=1MHz		2890		pF
Reverce transfer capacitnce	Crss	VDS=25V, VGS=0V, f=1MHz		105		pF
Output capacitance	Coss	VDS=25V, VGS=0V, f=1MHz		219		pF
Turn-on delay time	td(on)	ID=15A, RL=3.3Ω, VDD=50V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		4.5		ns
Rise time	tr	ID=15A, RL=3.3Ω, VDD=50V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		6.5		ns
Turn-off delay time	td(off)	ID=15A, RL=3.3Ω, VDD=50V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		46		ns
Fall time	tf	ID=15A, RL=3.3Ω, VDD=50V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		20		ns
Diode reverse recovery time	trr	IF=30A, VGS=0V, di/dt=100A/µs		54		ns
Diode reverse recovery charge	Qrr	IF=30A, VGS=0V, di/dt=100A/µs		107		nC

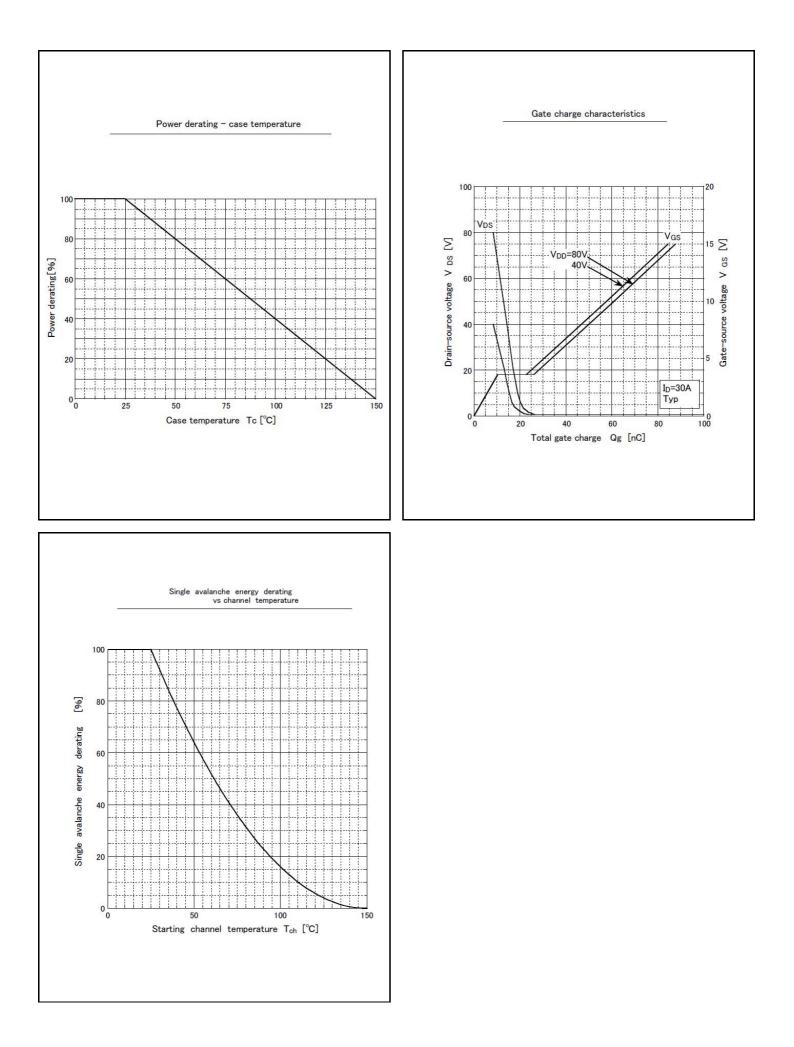
* : See the original Specifications

CHARACTERISTIC DIAGRAMS



3/7





 0.51 ± 0.1

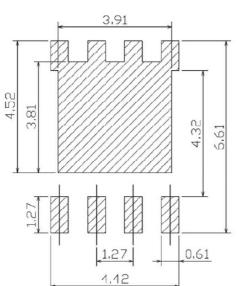
3.58±0.2

0.61±0.1

4

3.81-0.2 0.25±0.05 8 5 8 5 5,75±0,05 6±0,1 (0,25) (0,45) Ŧ 1 1 4 4 0.33-0.12 $0.41\substack{+0.1\\-0.08}$ 1,27 1±0.1 <u>ふ</u> 2. 端子配置 3. 製品質量: 0.09g(標準) Lead Assignment Package Weight: 0.09g(typ) MOS-FET 123 : Source : Gate 4.9±0.1 5678 : Drain

UNIT: mm



Notes

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